

/ Descriptions

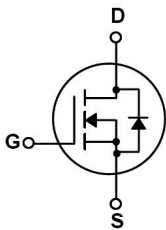
/ Features

≤ Ω Ω

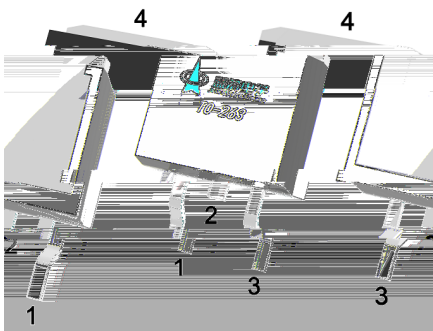
/ Applications

BMS

/ Equivalent Circuit



/ Pinning



/ Marking

/ Absolute Maximum Ratings(Ta=25)

		℃		
			±	
		℃		
	≤	θ		
		θ		

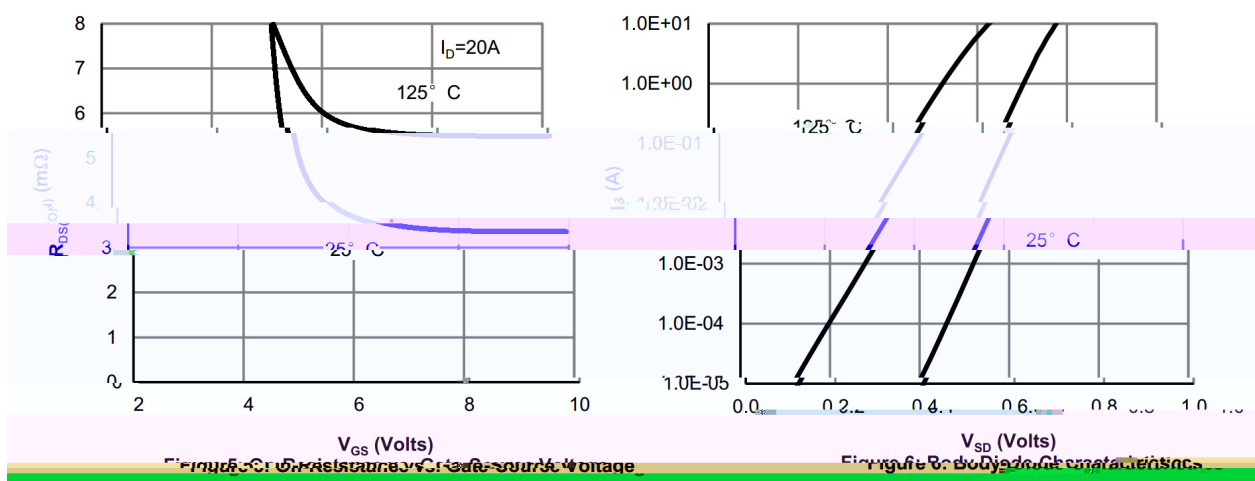
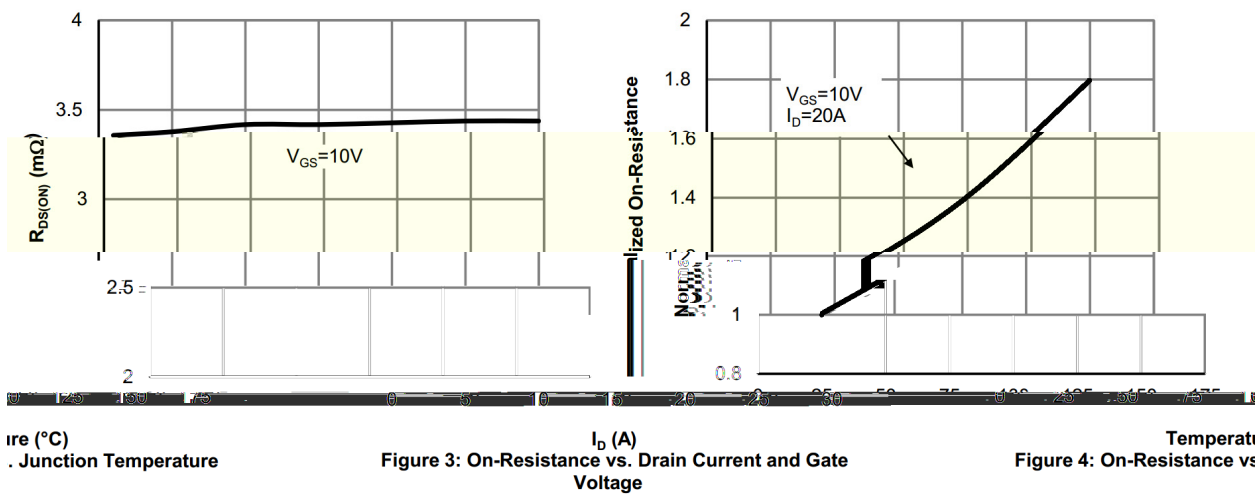
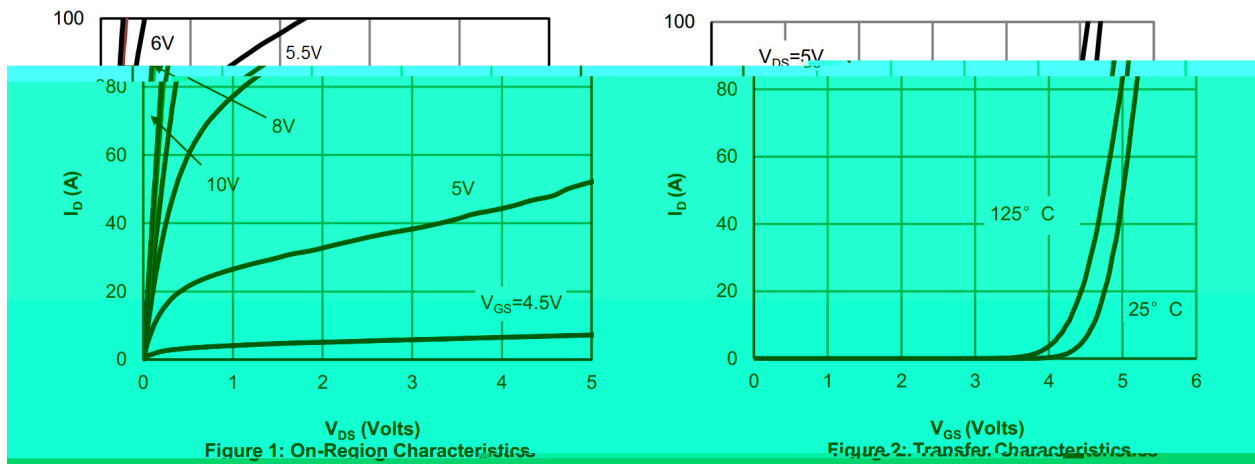
/ Electrical Characteristics(Ta=25)

Drain-Source Breakdown Voltage						
					±	
						Ω
						Ω

/ Electrical Characteristics(Ta=25)

		Ω Ω				

/ Electrical Characteristic Curve



/ Electrical Characteristic Curve

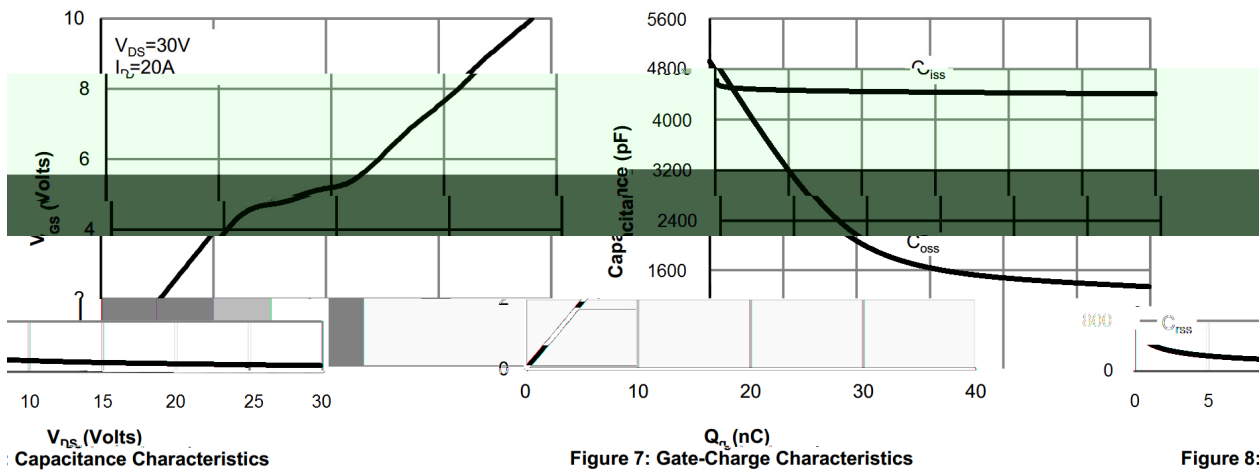
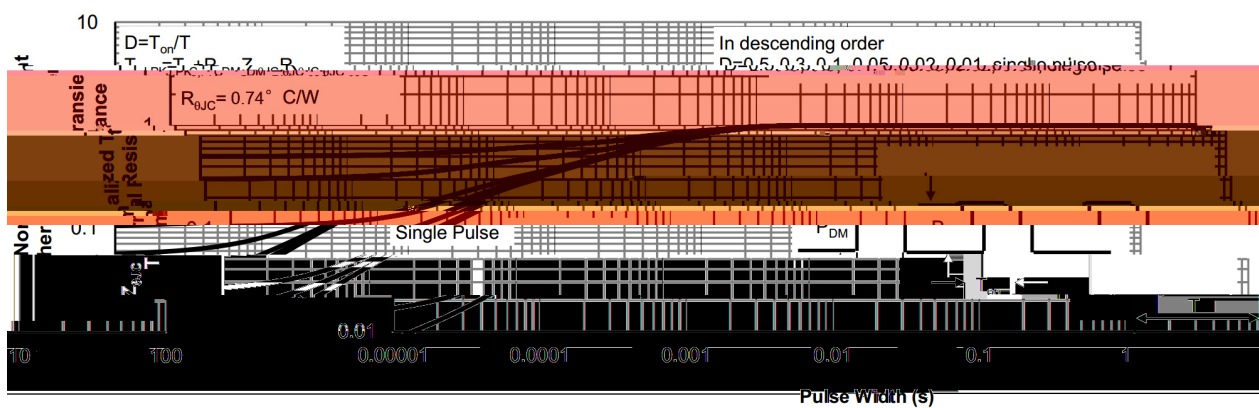
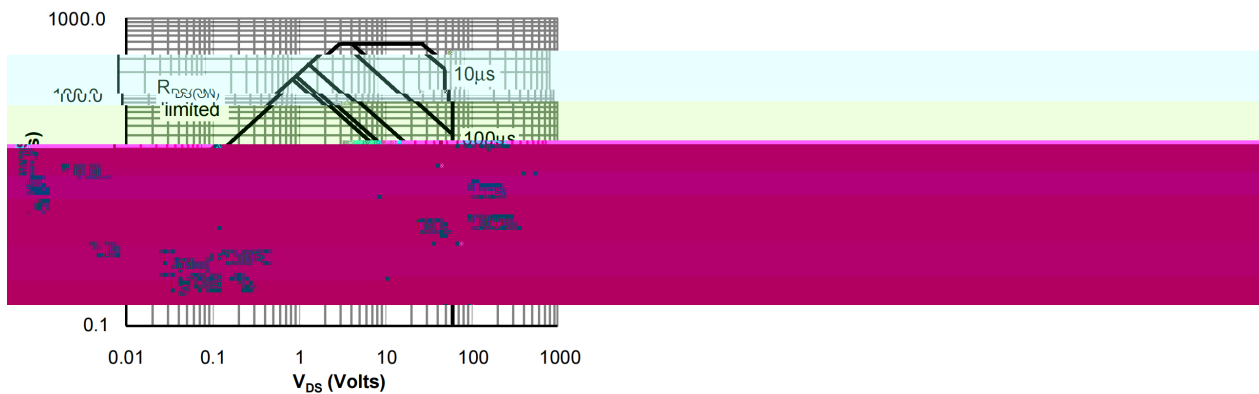
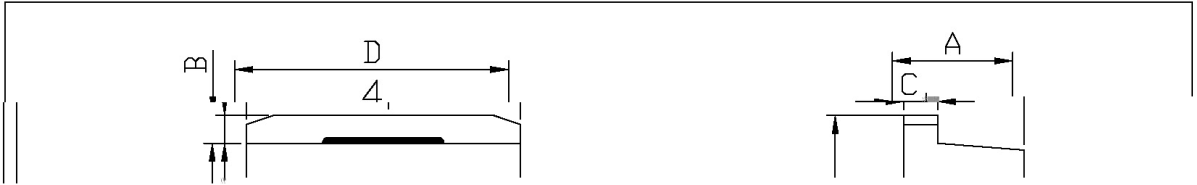


Figure 8:



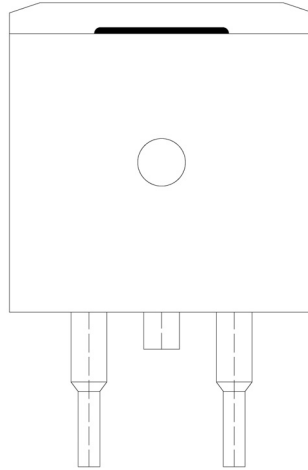
/ Package Dimensions



单位: mm						
Symbol	Dimensions In Millimeters		Symbol	Dimensions In Millimeter		
	Min	Max		Min	Max	
A	4.30	4.70	F	0.00	0.10	
B	1.00	1.40	e1	2.24	2.74	
b	0.70	0.90	e2	4.88	5.28	
b1	1.15	1.35	L1	15.00	16.00	
b2	0.40	0.60	L2	2.24	2.64	
C	1.20	1.40	L3	1.20	1.60	
D	9.80	10.20				

TT-263

/ Marking Instructions



BR

035N06SH

() / Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ±

/ Packaging SPEC.

						"		

/ Notices